## **Amendments to the Abstract**:

## **ABSTRACT**

Please replace the abstract that appears on page 12 of the specification with the following revised abstract which is submitted on a separate sheet.

## **ABSTRACT**

The invention relates to a A sonic or ultrasonic transducer [[(1)]], which is embodied as a radial oscillator. So that the sonic or ultrasonic transducer can be used at high temperatures, [[the]] a matching layer [[(4)]] is located between the radial oscillator and the atmosphere into which the ultrasonic signals are transmitted[[,]] and The matching layer is made from a material that has a dimensional stability up to a temperature which lies above the temperature at the installation location of the sonic or ultrasonic transducer [[(1)]]. Furthermore, the matching layer is selected such that its material-specific coefficient of thermal expansion is greater than that of the materials of [[the]] a piezoelectric unit [[(2)]] and [[the]] a coupling ring [[(3)]], and that the modulus of elasticity of the material of the matching layer [[(4)]] is at least one order of magnitude smaller than that of the piezoelectric unit [[(2)]] and/or the coupling ring [[(3)]].